



Accretech UF3000 Automatic Wafer Prober

with following options :

- Probe Mark Inspection
- GP-IB with cable
- Automatic probe to pad alignment
- Multi-Die probing up to 256 DUTs
- Internal printer
- Multi function cleaning pad
- Ethernet I/F
- RS 232 I/F
- Automatic Needle Height Alignment
- Soak Time SW option
- Adding the max no. of measuring die to 999.000
- Bump alignment incl. post card alignment
- Extension to 512 DUT
- Sealing kit for -40 °C
- Movable stand
- Touch sensor option
- Cassette loader cover
- Tester I/F for Advantest T5593

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